

Code	VIC
Company name	Vingroup Joint Stock Company
Date	03/28/2024
Subject	Notice of bond public offering

Content:

Vingroup Joint Stock Company announces the information on the 2nd bond public offering as follows:

A. Information on VICH2326002 bond:

1. Issuer: Vingroup Joint Stock Company
2. Bond name: **VICH2326002**
3. Bond type: non-convertible bond, unsecured and without warrants
4. Par value: VND100,000/bond
5. Offering volume: 20,000,000 bonds
6. Offering value (at par value): VND2,000,000,000,000
7. Term: 36 months
8. Interest rate:
9. For the first two interest periods: 15%/year
10. For nest interest periods: sum of 4.5%/year and the reference interest rate.
11. Interest payment term: Once every six months
12. Offering price: VND100,000/bond
13. Distribution method: via the issuance agent – Techcom Securities Joint Stock Company (TCBS)
14. Minimum registration volume:
 - For individual investors: minimum 500 bonds, equivalent to VND50,000,000 (at par value)
 - For institutional investors: minimum 5,000 bonds, equivalent to VND500,000,000 (at par value).
15. Time for subscription and payment: from December 26, 2023 to January 24, 2024
16. Place to receive subscription: at Techcom Securities Joint Stock Company (TCBS)
17. Estimated issue date: January 24, 2024
18. Bank for blocking depository money:
 - Account holder: Vingroup Joint Stock Company
 - Account number: 19010302487134
 - Bank: Techcombank.

B. Information on VICH2325005 bond:

1. Issuer: Vingroup Joint Stock Company
2. Bond name: **VICH2326002**
3. Bond type: non-convertible bond, unsecured and without warrants
4. Par value: VND100,000/bond
5. Offering volume: 20,000,000 bonds
6. Offering value (at par value): VND2,000,000,000,000
7. Term: 24 months
8. Interest rate:
 - For the first two interest periods: 14.5%/year
 - For nest interest periods: sum of 4%/year and the reference interest rate.
9. Interest payment term: Once every six months
10. Offering price: VND100,000/bond
11. Distribution method: via the issuance agent – Techcom Securities Joint Stock Company (TCBS)
12. Minimum registration volume:
 - For individual investors: minimum 500 bonds, equivalent to VND50,000,000 (at par value)
 - For institutional investors: minimum 5,000 bonds, equivalent to VND500,000,000 (at par value).
13. Time for subscription and payment: from December 26, 2023 to March 13, 2024
14. Place to receive subscription: Techcom Securities Joint Stock Company (TCBS)
15. Estimated issue date: March 13, 2024.